

FUTURE TECHNOLOGIES SYMPOSIUM

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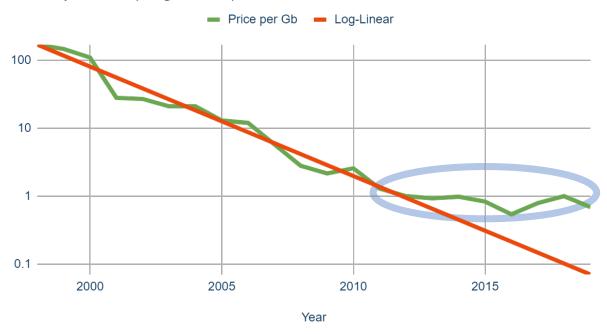
Software Defined Memory: A Meta perspective

Chris Petersen, Hardware Systems Technologist, Meta



Increasing Memory Cost and Power

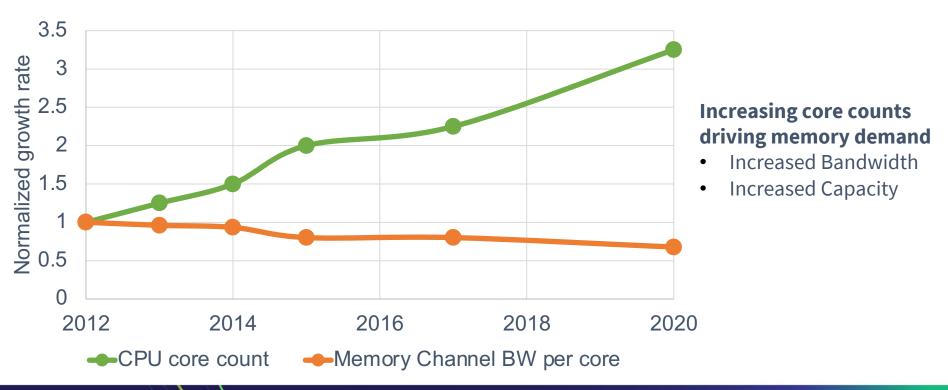
Price per Gb (Log Scale)



Memory an increasing % of system power and cost

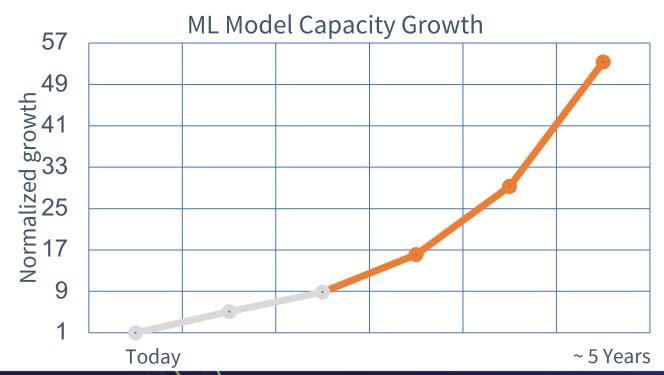
- Memory price (cost/bit) flat due to scaling challenges
- Memory power scaling with speed

Increasing Core Counts Drives Growth





Machine Learning Growth



ML Models are growing rapidly

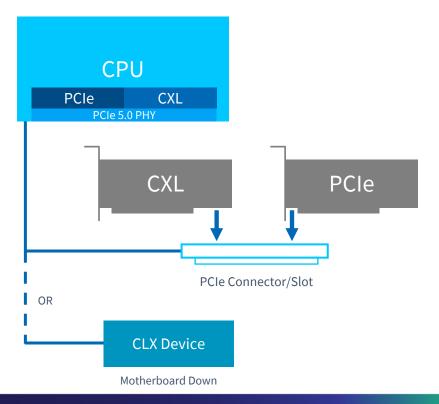
- ~50X growth in ~5 years
- Existing memory hierarchy can't keep pace



Compute Express Link (CXL) Introduction

Processor Interconnect:

- Open industry standard
- High-bandwidth, low-latency
- Coherent interface
- Leverages PCI Express[®]
- Widths: x4, x8, x16

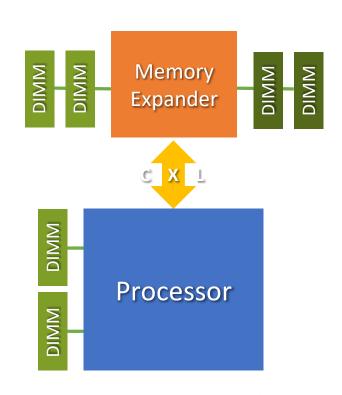


Requirements: CXL Memory Tiers Memory, not storage Cache-line reads/writes Scalable Heterogenous **CPU** Standard interfaces **DRAM** CXL-**Bandwidth Memory** attached **Capacity Memory NAND SSD**



Bandwidth Memory Tier

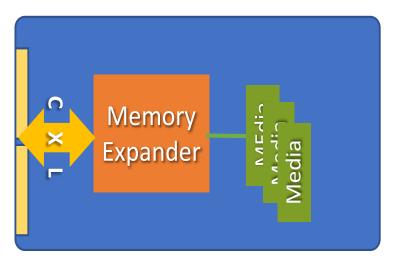
- Use Cases: Warm Pages, Page Migration
- BW: BW per GB close to that of DDR4 memory
- Latency: NUMA-like
- **Power:** ~90% of DDR5 at ISO capacity
- Capacity: Scales with standard RDIMMs
- **Form factor:** Initial solutions focused on "chip down + DIMMs"





Capacity Memory Tier

- Use Cases: Caching and ML Models
- BW: BW per GB 5-10% of DDR5 memory
- Latency: Hundreds of ns
- Power: ~50% of DDR5 at ISO capacity
- Capacity: 256GB 1TB
- Form factors: Use hot-pluggable form factors (like E1 or E3)

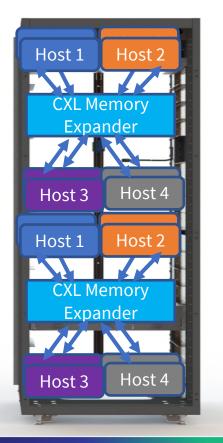




CXL Memory Evolution

Direct-attach **Small Pools CPU** Host 2 Host 1 DDR* **CXL** CXL **CXL** DIMMs CXL CXL Controller Memory **Expander** Media **CXL CXL** CXL Host 3 Host 4 Memory

Rack-scale Pools





Parting thoughts

- Lots of work ahead of us! Industry collaboration is critical.
- Think at the system level including SW integration, and also in phases
- Multiple CXL memory tiers are needed for multiple use cases.
 One size does **not** fit all!







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